

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT8135459

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MOLEX KOREA LTD	06/08/2023
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	MOLEX, LLC
<b>Street Address:</b>	2222 WELLINGTON COURT
<b>City:</b>	LISLE
<b>State/Country:</b>	ILLINOIS
<b>Postal Code:</b>	60532
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17706598
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	630-718-5534
<b>Email:</b>	paralegal_koch@cpaglobal.com
<b>Correspondent Name:</b>	MOLEX, LLC
<b>Address Line 1:</b>	2222 WELLINGTON COURT
<b>Address Line 4:</b>	LISLE, ILLINOIS 60532
<b>ATTORNEY DOCKET NUMBER:</b>	MX-2021-PAT-0056-US-NP
<b>NAME OF SUBMITTER:</b>	MAHIKA SINGH
<b>SIGNATURE:</b>	/MAHIKA SINGH/
<b>DATE SIGNED:</b>	08/28/2023
<b>Total Attachments: 2</b>	
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source=MX-2021-PAT-0056-US-NP_company to company_with date#page2.tif	

## ASSIGNMENT

WHEREAS, Molex Korea Ltd, a limited liability company having a place of business at Sandan-ro 169, Wonsi-Dong, Danwon-gu, Ansan-si Gyeonggi Province, South Korea 425-090 ("Assignor"), owns or owned an interest in certain new and useful inventions for "PLUG CONNECTOR FOR BOARD-TO-BOARD CONNECTOR AND CONNECTOR ASSEMBLY INCLUDING THE SAME", for which a U.S. patent application ("Application") was filed on March 29, 2022, and accorded Serial No. 17/706,598 (Docket Number MX-2021-PAT-0056-US-NP); and

WHEREAS, Molex, LLC, a limited liability company having a place of business at 2222 Wellington Court, Lisle, Illinois 60532 ("Assignee"), desires acquiring or has acquired Assignor's interest in the above-identified inventions, the Application, and any related U.S. or foreign patent applications and patents;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged:

Assignor hereby authorizes Assignee to file any of the above-referenced patent applications in the name of Assignee, and Assignor authorizes and requests the patent office of any country to issue any patent granted from any of the above-referenced patent applications in the name of Assignee;

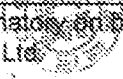
Assignor by this Assignment does hereby sell, assign, and transfer, or by virtue of employment or applicable agreements has sold, assigned, and transferred, to Assignee, Assignor's entire right, title, and interest in and to the above-identified inventions and all improvements and modifications to the above-identified inventions, the Application, any U.S. or foreign patent applications related to the above-identified inventions, any U.S. or foreign patent applications claiming priority to any of the above-referenced patent applications, including any nonprovisional, divisional, continuation, continuation-in-part, reexamination, reissue, extension, substitution, or renewal of any of the above-referenced patent applications, any right to claim priority arising from or required for any of the above-referenced patent applications under any applicable convention, treaty, statute, or regulation, any other right, privilege, or form of protection related to the above-identified inventions or any of the above-referenced patent applications, and any U.S. or foreign patent granted from any of the above-referenced patent applications, to the full end of the term of the patent, to be held and enjoyed by Assignee as fully and entirely as it would have been held and enjoyed by Assignor, including the right to pursue, collect, and retain damages and any other remedies arising from any past, present, or future infringement of patents granted from the above-referenced patent applications;

Assignor hereby warrants and covenants that Assignor has not and will not execute any assignment or other instrument in conflict with this Assignment;

Assignor hereby covenants and agrees to perform any reasonable act that may be necessary or desirable to aid Assignee, its successors, legal representatives, and assigns, to obtain, maintain, and enforce protection in the U.S. and foreign countries for the above-identified inventions, above-referenced patent applications, and patents granted therefrom, including signing lawful papers, executing patent applications, making assignments, rightful oaths, and declarations, and testifying in judicial or administrative proceedings; and

Assignor and Assignee agree that this Assignment may be electronically signed, and that the electronic signatures appearing on this Assignment are the same as handwritten signatures for the purposes of validity, enforceability, and admissibility.

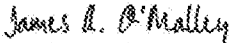
Case Ref. No. MX-2021-PAT-0056-US-NP

  
\_\_\_\_\_  
Officer, Authorized Signatory on behalf of  
Assignor: Molex Korea Ltd.  
Date: 6/8/2023

DECLARATION OF ACCEPTANCE

Assignee hereby acknowledges and accepts the aforementioned assignment of right, title, and interest and confirms consent that this Assignment may be recorded in appropriate patent

offices.  
Signed by:

  
\_\_\_\_\_  
James A. O'Malley, Authorized Signatory on behalf of  
Assignee: Molex, LLC  
Date: 8/17/2023 9:29:25 AM EDT